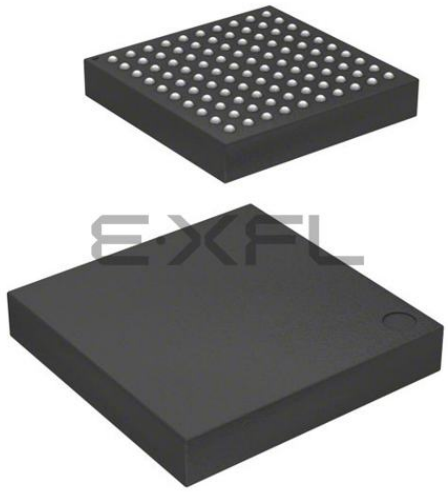

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I²C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	78
Program Memory Size	768KB (768K x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 14x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631addlj-u0

Table 1.1 Outline of Specifications (3/6)

Classification	Module/Function	Description
I/O ports	General I/O ports	• I/O ports for the 177-pin TFLGA, 176-pin LFBGA and 176-pin LQFP I/O pins: 133 Input pins: 1 Pull-up resistors: 133 Open-drain outputs: 133 5-V tolerance: 18 • I/O ports for the 145-pin TFLGA and 144-pin LQFP I/O pins: 111 Input pins: 1 Pull-up resistors: 111 Open-drain outputs: 111 5-V tolerance: 18 • I/O ports for the 100-pin TFLGA (in the planning stage) and 100-pin LQFP I/O pins: 78 Input pins: 1 Pull-up resistors: 78 Open-drain outputs: 78 5-V tolerance: 17 • I/O ports for the 64-pin TFLGA I/O pins: 39 Input pin: 1 Pull-up resistors: 39 Open-drain outputs: 39 5-V tolerance: 8 • I/O ports for the 64-pin LQFP I/O pins: 42 Input pin: 1 Pull-up resistors: 42 Open-drain outputs: 42 5-V tolerance: 8 8-bit port switching function • I/O ports for the 48-pin LQFP I/O pins: 30 Input pin: 1 Pull-up resistors: 30 Open-drain outputs: 30 5-V tolerance: 6 8-bit port switching function

Table 1.1 Outline of Specifications (4/6)

Classification	Module/Function	Description
Timers	16-bit timer pulse unit (TPUa)	• (16 bits x 6 channels) x 2 unit • Maximum of 16 pulse-input/output possible • Select from among seven or eight counter-input clock signals for each channel • Input capture/output compare function • Output of PWM waveforms in up to 15 phases in PWM mode • Buffered operation and phase-counting mode (two phase encoder input) depending on the channel • Support for cascade-connected operation (32 bits x 2 channels) • PPG output trigger can be generated • Capable of generating conversion start triggers for the A/D converters • Signals from the input capture pins are input via a digital filter • Clock frequency measuring method
	Multi-function timer pulse unit 2 (MTU2a)	• (16 bits x 6 channels) x 1 unit • Time bases for the 6 × 16-bit timer channels can be provided via up to sixteen pulse-input/output lines and three pulse-input lines • Select from among eight counter-input clock signals for each channel (PCLK/1, PCLK/4, PCLK/16, PCLK/64, MTCLKA, MTCLKB, MTCLKC, MTCLKD) other than channel 5, for which only four signals are available. • Input capture function • 21 output compare/input capture registers • Complementary PWM output mode • Reset synchronous PWM mode • Phase-counting mode • Generation of triggers for A/D converter conversion • Digital filter • Signals from the input capture pins are input via a digital filter • PPG output trigger can be generated • Clock frequency measuring function
	Frequency measuring method (MCK)	The MTU or unit 0 TPU module can be used to monitor the main clock, subclock, HOCO clock, LOCO clock, and PLL clock for abnormal frequencies.
	Port output enable 2 (POE2a)	Controls the high-impedance state of the MTU's waveform output pins
	Programmable pulse generator (PPG)	• (4 bits x 4 groups) x 2 units • Pulse output with the MTU2 or TPU output as a trigger • Maximum of 32 pulse-output possible
	8-bit timers (TMR)	• (8 bits x 2 channels) x 2 units • Select from among seven internal clock signals (PCLK/1, PCLK/2, PCLK/8, PCLK/32, PCLK/64, PCLK/1024, PCLK/8192) and one external clock signal • Capable of output of pulse trains with desired duty cycles or of PWM signals • The 2 channels of each unit can be cascaded to create a 16-bit timer • Generation of triggers for A/D converter conversion • Capable of generating baud-rate clocks for SCI5, SCI6, and SCI12
	Compare match timer (CMT)	• (16 bits x 2 channels) x 2 units • Select from among four internal clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)
	Realtime clock (RTCa)	• Clock sources: Main clock, subclock • Clock and calendar functions Interrupt sources: Alarm interrupt, periodic interrupt, and carry interrupt • Battery backup operation • Time-capture facility for three values
	Watchdog timer (WDTA)	• 14 bits x 1 channel • Select from among 6 counter-input clock signals (PCLK/4, PCLK/64, PCLK/128, PCLK/512, PCLK/2048, PCLK/8192)
	Independent watchdog timer (IWDTa)	• 14 bits x 1 channel • Counter-input clock: IWDT-dedicated on-chip oscillator • Dedicated clock/1, dedicated clock/16, dedicated clock/32, dedicated clock/64, dedicated clock/128, dedicated clock/256

Table 1.2 Comparison of Functions for Different Packages in the RX63N/RX631 Group

Functions		RX63N Group			RX631 Group					
Package		177-pin 176-pin	145-pin 144-pin	100-pin	177-pin 176-pin	145-pin 144-pin	100-pin	64-pin LQFP	64-pin TFLGA	48-pin
External bus width	External bus width	32 bits	16 bits		32 bits	16 bits		Not available		
	SDRAM area controller	Available		Not available	Available			Not available		
DMA	DMA controller	Ch. 0 to 3			Ch. 0 to 3					
	EXDMA controller	Ch. 0 and 1			Ch. 0 and 1			Not available		
	Data transfer controller	Available			Available					
Timers	16-bit timer pulse unit	Ch. 0 to 11		Ch. 0 to 5	Ch. 0 to 11			Ch. 0 to 5		
	Multi-function timer pulse unit 2	Ch. 0 to 5			Ch. 0 to 5					
	Port output enable 2	Available			Available					
	Programmable pulse generator	Ch. 0 and 1			Ch. 0 and 1					
	8-bit timers	Ch. 0 to 3			Ch. 0 to 3					
	Compare match timer	Ch. 0 to 3			Ch. 0 to 3					
	Realtime clock	Available			Available					Not available
	Watchdog timer	Available			Available					
	Independent watchdog timer	Available			Available					
Communication function	Ethernet controller	Available			Not available					
	DMA controller for Ethernet controller	Available			Not available					
	USB 2.0 host/function module	Ch. 0 and 1		Ch.0	Ch. 0 and 1		Ch.0		Ch. 0 and 1	Ch.0
	Serial communications interfaces (SCIc)	Ch. 0 to 11		Ch. 0 to 3, 5, 6, 8 and 9	Ch. 0 to 11		Ch. 0 to 3, 5, 6, 8 and 9	Ch. 1, 5, 6, 8 and 9		Ch. 1, 5, 6, and 8
	Serial communications interfaces (SCId)	Ch. 12			Ch. 12					
	I^2C bus interfaces	Ch. 0 to 3		Ch.0 and 2	Ch. 0 to 3		Ch.0 and 2	Ch.2		
	IEBus	Available			Available					
	Serial peripheral interfaces	Ch.0 to 2		Ch. 0 and 1	Ch.0 to 2			Ch. 0 and 1		
	CAN module	For 1.5 M or more: Ch. 0 to 2, For 1 M or less: Ch. 0 and 1		Ch. 0 and 1	For 1.5 M or more: Ch. 0 to 2, For 1 M or less: Ch. 0 and 1		Ch. 0 and 1	Ch.1		
	Parallel data capture unit (PDC)	Not available			Available			Not available		
12-bit A/D converter (channel)		AN000 to 020		AN000 to 013	AN000 to 020		AN000 to 013	AN000 to 004, 006, 008 to 013		AN000 to 002, 006, 009 to 012
10-bit A/D converter (channel)		AN0 to 7			AN0 to 7			Not available		
D/A converter		Ch. 0 and 1		Ch.1	Ch. 0 and 1		Ch.1	Ch.1		Not available
Temperature sensor		Available			Available					
CRC calculator		Available			Available					
Unique ID		Available (only for the G version)								
Off-board programming (parallel programmer mode)		Available						Not available		
Sub-clock oscillator (for low clock loads)		Available						Not available		
Sub-clock oscillator (for standard clock loads)		Available								Not available
Battery backup function		Available								Not available
I/O port switching function		Not available			Not available			Available		

1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no.

Table 1.3 List of Products (1/8)

Group	Part No.	Package	ROM Capacity	RAM Capacity	E2 Data Flash	Operating Frequency (Max.)	Operating Temp. Range
RX63N (D version)	R5F563NECDLC	PTLG0177KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDLC	PTLG0177KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDLC	PTLG0177KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDLC	PTLG0177KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDLC	PTLG0177KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDLC	PTLG0177KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDLC	PTLG0177KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDLC	PTLG0177KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDBG	PLBG0176GA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDBG	PLBG0176GA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDBG	PLBG0176GA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDBG	PLBG0176GA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDBG	PLBG0176GA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDBG	PLBG0176GA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDBG	PLBG0176GA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDBG	PLBG0176GA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFHDFC	PLQP0176KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFDDFC	PLQP0176KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKHDFC	PLQP0176KB-A*1	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKDDFC	PLQP0176KB-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDFC	PLQP0176KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDFC	PLQP0176KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJHDFC	PLQP0176KB-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJDDFC	PLQP0176KB-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGHDFC	PLQP0176KB-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGDDFC	PLQP0176KB-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDFC	PLQP0176KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDFC	PLQP0176KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYHDFC	PLQP0176KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYDDFC	PLQP0176KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWHDFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWDDFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWGDFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWCDFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDFC	PLQP0176KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDFC	PLQP0176KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDFC	PLQP0176KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDFC	PLQP0176KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDLK	PTLG0145KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDLK	PTLG0145KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDLK	PTLG0145KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C

RX63N Group, RX631 Group
PTLG0100JA-A (100-pin TFLGA)
(Top view)

	A	B	C	D	E	F	G	H	J	K	
10	PE2	PE3	PE4	PA0	PA3	VSS	VCC	PB7	PC1	PC2	10
9	PE1	PD7	PE5	PA1	PA5	PA7	PB1	PB6	PC0	PC3	9
8	PE0	PD6	PD5	PE7	PA4	PB0	PB4	PC6	PC4	PC5	8
7	PD4	PD3	PD2	PE6	PA6	PB2	PB5	PC7	P50	P51	7
6	PD0	PD1	P47	P46	PA2	PB3	P52	P54	VCC_ USB	USB0_ DP	6
5	P43	P44	P42	P45	P41	P12	P53	P55	VSS_ USB	USB0_ DM	5
4	VREFL0	P40	VREFH0	VBATT	P34	P32	P27	P15	P13	P14	4
3	P07	AVCC0	PJ3	MD/ FINED	RES#	P35	P30	P16	P17	P20	3
2	VREFH	AVSS0	VREFL	XCOUT	VSS	VCC	P31	P25	P21	P22	2
1	P05	EMLE	VCL	XCIN	XTAL	EXTAL	P33	P26	P24	P23	1
	A	B	C	D	E	F	G	H	J	K	

Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.10, List of Pins and Pin Functions (100-Pin LQFP).

Figure 1.8 Pin Assignment (100-Pin TFLGA)

RX631 Group
PTLG0064JA-A (64-pin TFLGA)
(Top perspective view)

	A	B	C	D	E	F	G	H	
8	PE3	PE4	PA0	PA3	PB0	PB3	PB6	PB7	8
7	PE2	PE1	PE5	PA1	VSS	PB5	PC3	PC2	7
6	VREFL	P46	PE0	PA4	VCC	PB1	PC6	USB1_DP	6
5	VREFH	P44	P43	PA6	PC4	P15	VCC_USB	USB1_DM	5
4	VREFL0	P42	P41	P14	P16	PC5	VSS_USB	USB0_DP	4
3	VREFH0	P40	EMLE	P27	P30	P31	VCC_USB	USB0_DM	3
2	AVCC0	AVSS0	MD/FINED	RES#	VBATT	P35	P26	P17	2
1	P05	VCL	XCIN	XCOUT	VSS	VCC	EXTAL	XTAL	1
	A	B	C	D	E	F	G	H	

Figure 1.10 Pin Assignment (64-pin TFLGA)

Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA) (5/5)

Pin No. 145-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
N7	TRDATA3	P55	WAIT#/ EDREQ0	MTIOC4D/TMO3	CRX1/ET_EXOUT	IRQ10	
N8	VSS						
N9		PC7	A23/CS0#	MTIOC3A/MTCLKB/ TIOCB6/TMO2/PO31	TXD8/SMOSI8/SSDA8/ MISOA/ET_COL	IRQ14	
N10	TRSYNC	P82	EDREQ1	MTIOC4A/PO28	TXD10/SMOSI10/SSDA10/ ET_ETXD1/RMII_TXD1		
N11		PC3	A19	MTIOC4D/TCLKB/PO24	TXD5/SMOSI5/SSDA5/ IETXD/ET_TX_ER		
N12		P75	CS5#	PO20	SCK11/ET_ERXD0/ RMII_RXD0		
N13		P74	CS4#	PO19	CTS11#/RTS11#/SS11#/ ET_ERXD1/RMII_RXD1		

Note 1. The BCLK function is multiplexed with the I/O port function for pin P53, so the port function is not available if the external bus is enabled.

Note 2. Enabled only for the ROM capacity: 2 Mbytes/1.5 Mbytes

Table 1.8 List of Pins and Pin Functions (144-Pin LQFP) (5/5)

Pin No. 144-pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
125		PD1	D1[A1/D1]	MTIOC4B/TIOCB7/ TCLKG	MOSIC/CTX0	IRQ1	AN009
126		PD0	D0[A0/D0]	TIOCA7		IRQ0	AN008
127		P93	A19		CTS7#/RTS7#/SS7#		AN017
128		P92	A18		RXD7/SMISO7/SSCL7		AN016
129		P91	A17		SCK7		AN015
130	VSS						
131		P90	A16		TXD7/SMOSI7/SSDA7		AN014
132	VCC						
133		P47				IRQ15-DS	AN007
134		P46				IRQ14-DS	AN006
135		P45				IRQ13-DS	AN005
136		P44				IRQ12-DS	AN004
137		P43				IRQ11-DS	AN003
138		P42				IRQ10-DS	AN002
139		P41				IRQ9-DS	AN001
140	VREFL0						
141		P40				IRQ8-DS	AN000
142	VREFH0						
143	AVCC0						
144		P07				IRQ15	ADTRG0#

Note 1. The BCLK function is multiplexed with the I/O port function for pin P53, so the port function is not available if the external bus is enabled.

Note 2. Enabled only for the ROM capacity: 2 Mbytes/1.5 Mbytes

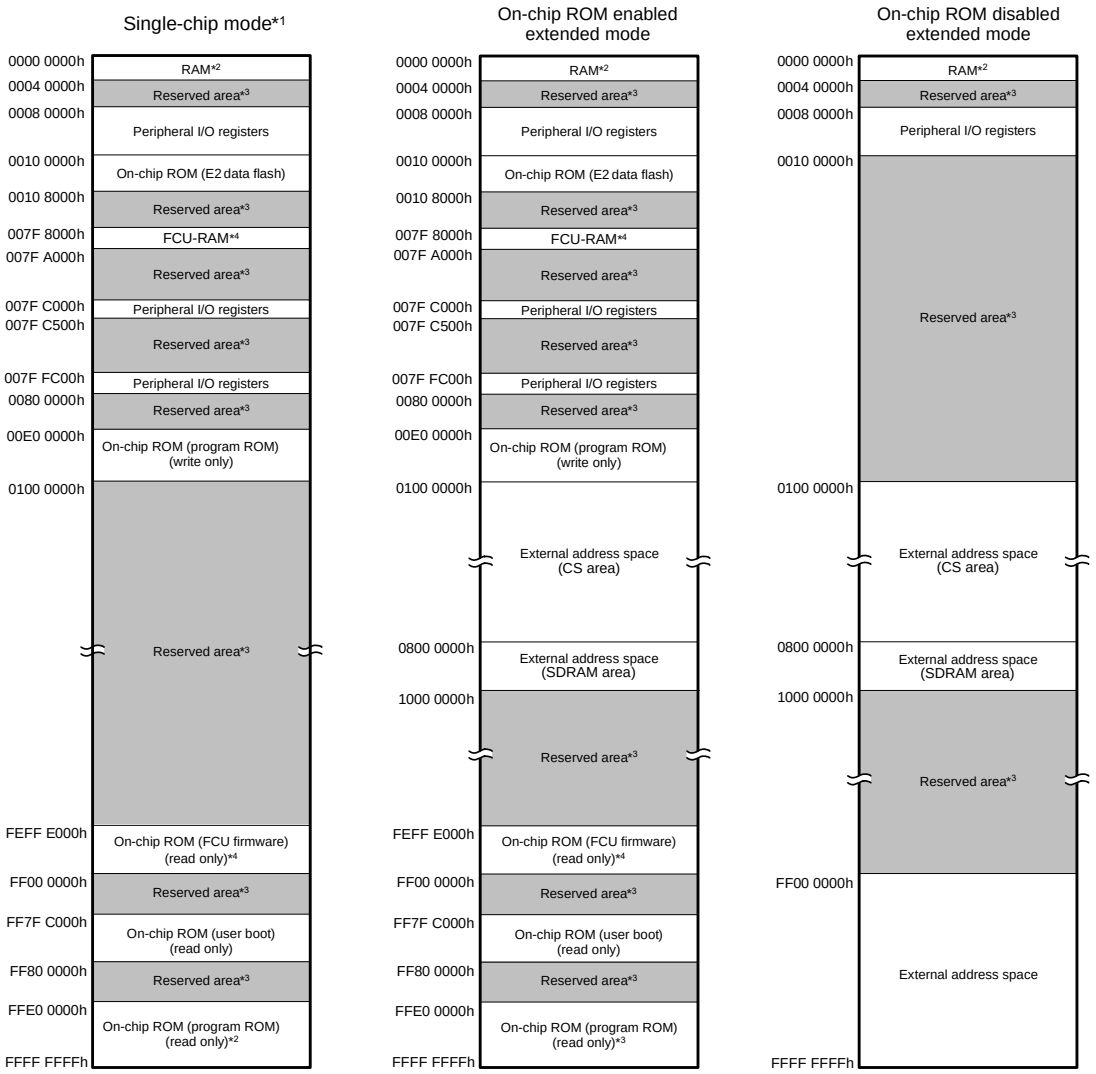
Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA) (5/5)

Pin No. 100-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD AD DA
K2		P22	EDREQ0	MTIOC3B/ MTCLKC/ TIOCC3/TMO0/ PO2	SCK0/USB0_DRPD		
K3		P20		MTIOC1A/ TIOCB3/ TMRI0/PO0	TXD0/SMOSI0/ SSDA0/USB0_ID	IRQ8	
K4		P14		MTIOC3A/ MTCLKA/ TIOCB5/ TCLKA/TMRI2/ PO15	CTS1#/RTS1#/ SS1#/CTX1/ USB0_DPUPE/ USB0_OVRCURA	IRQ4	
K5					USB0_DM		
K6					USB0_DP		
K7		P51	WR1#/BC1#/ WAIT#		SCK2/SSLB2		
K8		PC5	A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	SCK8/RSPCKA/ ET_ETXD2		
K9		PC3	A19	MTIOC4D/ TCLKB/PO24	TXD5/SMOSI5/ SSDA5/IETXD/ ET_TX_ER		
K10		PC2	A18	MTIOC4B/ TCLKA/PO21	RXD5/SMISO5/ SSCL5/SSLA3/ IERXD/ET_RX_DV		

Note 1. Enabled only for the ROM capacity of 768 Kbytes or more.
Note 2. The BCLK function is multiplexed with the I/O port function for pin P53, so the port function is not available if the external bus is enabled.

Table 1.10 List of Pins and Pin Functions (100-Pin LQFP) (3/4)

Pin No. 100-pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD AD DA
59		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD6/SMOSI6/SSDA6/ ET_ERXD0/ RMII_RXD0	IRQ4-DS	
60	VCC						
61		PB0	A8	MTIC5W/TIOCA3/PO24	RXD6/SMISO6/SSCL6/ RSPCKA/ET_ERXD1/ RMII_RXD1	IRQ12	
62	VSS						
63		PA7	A7	TIOCB2/PO23	MISOA/ET_WOL		
64		PA6	A6	MTIC5V/MTCLKB/ TIOCA2/TMCI3/PO22/ POE2#	CTS5#/RTS5#/SS5#/ MOSIA/ET_EXOUT		
65		PA5	A5	TIOCB1/PO21	RSPCKA/ET_LINKSTA		
66		PA4	A4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0/ET_MDC	IRQ5-DS	
67		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/SSCL5/ ET_MDIO	IRQ6-DS	
68		PA2	A2	PO18	RXD5/SMISO5/SSCL5/ SSLA3		
69		PA1	A1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2/ET_WOL	IRQ11	
70		PA0	A0/BC0#	MTIOC4A/TIOCA0/ PO16	SSLA1/ET_TX_EN/ RMII_TXD_EN		
71		PE7	D15[A15/D15]		MISOB	IRQ7	AN5
72		PE6	D14[A14/D14]		MOSIB	IRQ6	AN4
73		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B	RSPCKB/ET_RX_CLK/ REF50CK	IRQ5	AN3
74		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ PO28	SSLB0/ET_ERXD2		AN2
75		PE3	D11[A11/D11]	MTIOC4B/PO26/POE8#	CTS12#/RTS12#/ SS12#/MISOB/ ET_ERXD3		AN1
76		PE2	D10[A10/D10]	MTIOC4A/PO23	RXD12/SMISO12/ SSCL12/RXDX12/ SSLB3/MOSIB	IRQ7-DS	AN0
77		PE1	D9[A9/D9]	MTIOC4C/PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12/SSLB2/ RSPCKB		ANEX1
78		PE0	D8[A8/D8]		SCK12/SSLB1		ANEX0
79		PD7	D7[A7/D7]	MTIC5U/POE0#		IRQ7	AN7
80		PD6	D6[A6/D6]	MTIC5V/POE1#		IRQ6	AN6
81		PD5	D5[A5/D5]	MTIC5W/POE2#		IRQ5	AN013
82		PD4	D4[A4/D4]	POE3#		IRQ4	AN012
83		PD3	D3[A3/D3]	POE8#		IRQ3	AN011
84		PD2	D2[A2/D2]	MTIOC4D	CRX0*1	IRQ2	AN010
85		PD1	D1[A1/D1]	MTIOC4B	CTX0*1	IRQ1	AN009
86		PD0	D0[A0/D0]			IRQ0	AN008
87		P47				IRQ15-DS	AN007
88		P46				IRQ14-DS	AN006
89		P45				IRQ13-DS	AN005
90		P44				IRQ12-DS	AN004
91		P43				IRQ11-DS	AN003
92		P42				IRQ10-DS	AN002
93		P41				IRQ9-DS	AN001



Note 1. The address space in boot mode and user boot mode/USB boot mode is the same as the address space in single-chip mode.
Note 2. The capacity of ROM/RAM differs depending on the products.

ROM (byt)			RAM (byt)	
Capacity	**Address (for reading only)**	**Address (for programming only)**	**Capacity**	**Address**
2 M	FFE0 0000h to FFFF FFFFh	00E0 0000h to 00FF FFFFh	256 K	0000 0000h to 0003 FFFFh
			192 K	0000 0000h to 0002 FFFFh
			128 K	0000 0000h to 0001 FFFFh
1.5 M	FFE8 0000h to FFFF FFFFh	00E8 0000h to 00FF FFFFh	256 K	0000 0000h to 0003 FFFFh
			192 K	0000 0000h to 0002 FFFFh
			128 K	0000 0000h to 0001 FFFFh
1 M	FFF0 0000h to FFFF FFFFh	00F0 0000h to 00FF FFFFh	256 K	0000 0000h to 0003 FFFFh
			192 K	0000 0000h to 0002 FFFFh
			128 K	0000 0000h to 0001 FFFFh
768 K	FFF4 0000h to FFFF FFFFh	00F4 0000h to 00FF FFFFh		
512K	FFF8 0000h to FFFF FFFFh	00F8 0000h to 00FF FFFFh		
384K	FFFA 0000h to FFFF FFFFh	00FA 0000h to 00FF FFFFh		
256K	FFFC 0000h to FFFF FFFFh	00FC 0000h to 00FF FFFFh		
512K	FFF8 0000h to FFFF FFFFh	00F8 0000h to 00FF FFFFh	64K	0000 0000h to 0000 FFFFh
384K	FFFA 0000h to FFFF FFFFh	00FA 0000h to 00FF FFFFh		
256K	FFFC 0000h to FFFF FFFFh	00FC 0000h to 00FF FFFFh		

Note:See Table 1.3, List of Products, for the product type name.

Note 3. Reserved areas should not be accessed.
Note 4. For details on the FCU, see section 47, Flash Memory in the User's manual: Hardware.

Figure 3.1 Memory Map in Each Operating Mode

Table 4.1 List of I/O Registers (Address Order) (15/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 8036h	IWDT	IWDT reset control register	IWDTRCR	8	8	2, 3 PCLKB	2 ICLK	IWDTa
0008 8038h	IWDT	IWDT count stop control register	IWDTCSTPR	8	8	2, 3 PCLKB	2 ICLK	
0008 80C0h	DA	D/A data register 0	DADR0	16	16	2, 3 PCLKB	2 ICLK	DAa
0008 80C2h	DA	D/A data register 1	DADR1	16	16	2, 3 PCLKB	2 ICLK	
0008 80C4h	DA	D/A control register	DACR	8	8	2, 3 PCLKB	2 ICLK	
0008 80C5h	DA	DADRm format select register	DADPR	8	8	2, 3 PCLKB	2 ICLK	
0008 80C6h	DA	D/A A/D synchronous start control register	DAADSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8100h	TPUA	Timer start register	TSTR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8101h	TPUA	Timer synchronous register	TSYR	8	8	2, 3 PCLKB	2 ICLK	
0008 8108h	TPU0	Noise filter control register	NFCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8109h	TPU1	Noise filter control register	NFCR	8	8	2, 3 PCLKB	2 ICLK	
0008 810Ah	TPU2	Noise filter control register	NFCR	8	8	2, 3 PCLKB	2 ICLK	
0008 810Bh	TPU3	Noise filter control register	NFCR	8	8	2, 3 PCLKB	2 ICLK	
0008 810Ch	TPU4	Noise filter control register	NFCR	8	8	2, 3 PCLKB	2 ICLK	
0008 810Dh	TPU5	Noise filter control register	NFCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8110h	TPU0	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8111h	TPU0	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 8112h	TPU0	Timer I/O control register H	TIORH	8	8	2, 3 PCLKB	2 ICLK	
0008 8113h	TPU0	Timer I/O control register L	TIORL	8	8	2, 3 PCLKB	2 ICLK	
0008 8114h	TPU0	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8115h	TPU0	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8116h	TPU0	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 8118h	TPU0	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 811Ah	TPU0	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 811Ch	TPU0	Timer general register C	TGRC	16	16	2, 3 PCLKB	2 ICLK	
0008 811Eh	TPU0	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK	
0008 8120h	TPU1	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8121h	TPU1	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 8122h	TPU1	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 8124h	TPU1	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8125h	TPU1	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8126h	TPU1	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 8128h	TPU1	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 812Ah	TPU1	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 8130h	TPU2	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8131h	TPU2	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 8132h	TPU2	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 8134h	TPU2	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8135h	TPU2	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8136h	TPU2	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 8138h	TPU2	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 813Ah	TPU2	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 8140h	TPU3	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8141h	TPU3	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 8142h	TPU3	Timer I/O control register H	TIORH	8	8	2, 3 PCLKB	2 ICLK	
0008 8143h	TPU3	Timer I/O control register L	TIORL	8	8	2, 3 PCLKB	2 ICLK	
0008 8144h	TPU3	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8145h	TPU3	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8146h	TPU3	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 8148h	TPU3	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 814Ah	TPU3	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (25/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 A02Bh	SCI1	I²C mode register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIc, SCId
0008 A02Ch	SCI1	I²C status register	SISR	8	8	2, 3 PCLKB	2 ICLK	
0008 A02Dh	SCI1	SPI mode register	SPMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A040h	SCI2	Serial mode register	SMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A041h	SCI2	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	
0008 A042h	SCI2	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A043h	SCI2	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A044h	SCI2	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A045h	SCI2	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A046h	SCI2	Smart card mode register	SCMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A047h	SCI2	Serial extended mode register	SEM	8	8	2, 3 PCLKB	2 ICLK	
0008 A048h	SCI2	Noise filter setting register	SNFR2	8	8	2, 3 PCLKB	2 ICLK	
0008 A049h	SCI2	I²C mode register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 A04Ah	SCI2	I²C mode register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 A04Bh	SCI2	I²C mode register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 A04Ch	SCI2	I²C status register	SISR	8	8	2, 3 PCLKB	2 ICLK	
0008 A04Dh	SCI2	SPI mode register	SPMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A060h	SCI3	Serial mode register	SMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A061h	SCI3	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	
0008 A062h	SCI3	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A063h	SCI3	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A064h	SCI3	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A065h	SCI3	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A066h	SCI3	Smart card mode register	SCMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A067h	SCI3	Serial extended mode register	SEMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A068h	SCI3	Noise filter setting register	SNFR	8	8	2, 3 PCLKB	2 ICLK	
0008 A069h	SCI3	I²C mode register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 A06Ah	SCI3	I²C mode register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 A06Bh	SCI3	I²C mode register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 A06Ch	SCI3	I²C status register	SISR	8	8	2, 3 PCLKB	2 ICLK	
0008 A06Dh	SCI3	SPI mode register	SPMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A080h	SCI4	Serial mode register	SMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A081h	SCI4	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	
0008 A082h	SCI4	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A083h	SCI4	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A084h	SCI4	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A085h	SCI4	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A086h	SCI4	Smart card mode register	SCMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A087h	SCI4	Serial extended mode register	SEMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A088h	SCI4	Noise filter setting register	SNFR	8	8	2, 3 PCLKB	2 ICLK	
0008 A089h	SCI4	I²C mode register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 A08Ah	SCI4	I²C mode register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 A08Bh	SCI4	I²C mode register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 A08Ch	SCI4	I²C status register	SISR	8	8	2, 3 PCLKB	2 ICLK	
0008 A08Dh	SCI4	SPI mode register	SPMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A0A0h	SCI5	Serial mode register	SMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A0A1h	SCI5	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	
0008 A0A2h	SCI5	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A0A3h	SCI5	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A0A4h	SCI5	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A0A5h	SCI5	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	

5.3 AC Characteristics

Table 5.8 Operation Frequency Value (High-Speed Operating Mode)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit
Operation frequency	System clock (ICLK)		f	—*1	—	100	MHz
	Peripheral module clock (PCLKA)			—*1	—	100	
	Peripheral module clock (PCLKB)			—*2	—	50	
	FlashIF clock (FCLK)			—*3	—	50	
	External bus clock (BCLK)	Packages with 177 to 144 pins		—	—	100	
		Packages with 100 pins or less		—	—	50	
	BCLK pin output	Packages with 177 to 144 pins		—	—	50	
		Packages with 100 pins or less		—	—	25	
	SDRAM clock (SDCLK)	Packages with 177 to 144 pins only		—	—	50	
	SDCLK pin output	Packages with 177 to 144 pins only		—	—	50	
	USB clock (UCLK)			—	—	48	
	IEBUS clock (IECLK)			—	—	44.03	

Note 1. The ICLK and PCLKA frequencies must be the same and at least 12.5 MHz if the Ethernet controller is in use
Note 2. The PCLKB must run at a frequency of at least 24 MHz if the USB is in use.
Note 3. The FCLK must run at a frequency of at least 4 MHz when changing the ROM or E2 DataFlash memory contents.

Table 5.9 Operation Frequency Value (Low-Speed Operating Mode 1)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit
Operation frequency	System clock (ICLK)		f	—	—	1	MHz
	Peripheral module clock (PCLKA)			—	—	1	
	Peripheral module clock (PCLKB)			—	—	1	
	FlashIF clock (FCLK)			—	—	1	
	External bus clock (BCLK)	Packages with 177 to 144 pins		—	—	1	
		Packages with 100 pins or less		—	—	1	
	BCLK pin output	Packages with 177 to 144 pins		—	—	1	
		Packages with 100 pins or less		—	—	1	
	SDRAM clock (SDCLK)	Packages with 177 to 144 pins only		—	—	1	
	SDCLK pin output	Packages with 177 to 144 pins only		—	—	1	
	USB clock (UCLK)			—	—	1	
	IEBUS clock (IECLK)			—	—	1	

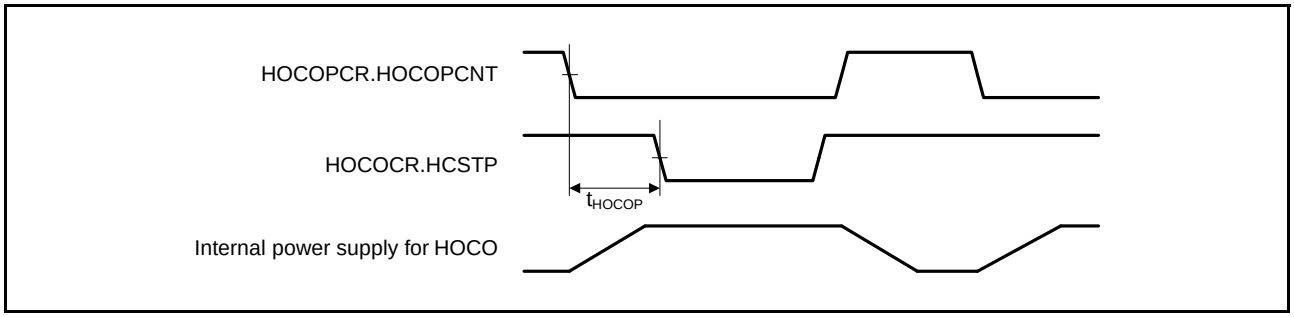


Figure 5.9 HOCO Power Supply Control Timing

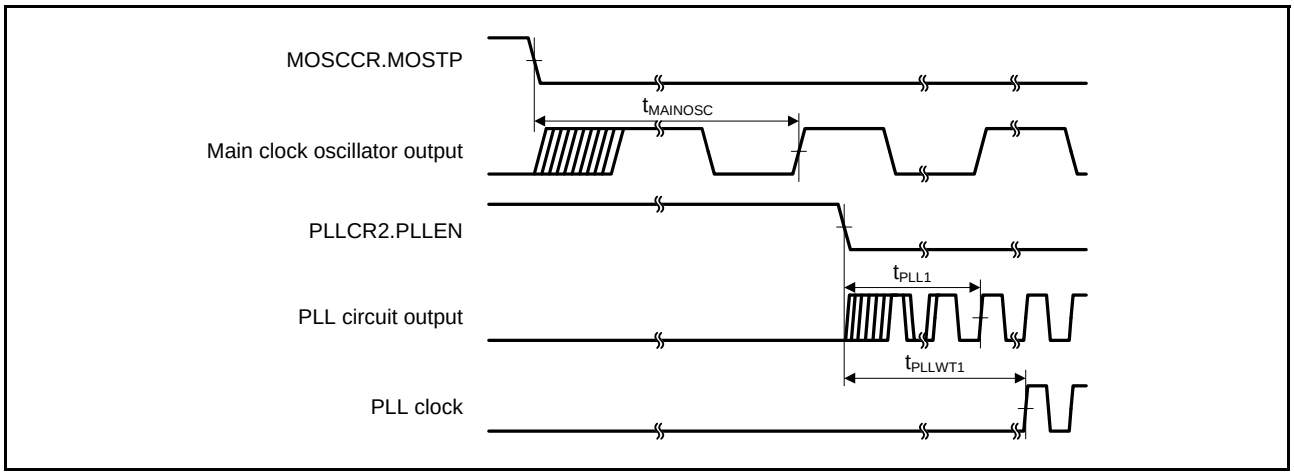


Figure 5.10 PLL Clock Oscillation Start Timing (PLL is Operated after Main Clock Oscillation Has Settled)

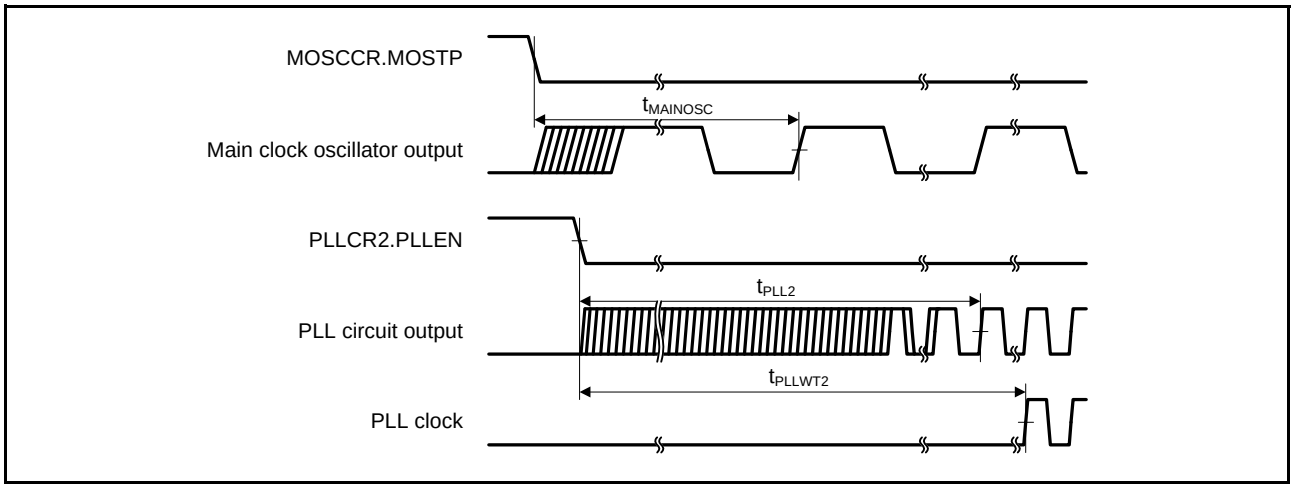


Figure 5.11 PLL Clock Oscillation Start Timing (PLL is Operated before Main Clock Oscillation Has Settled)

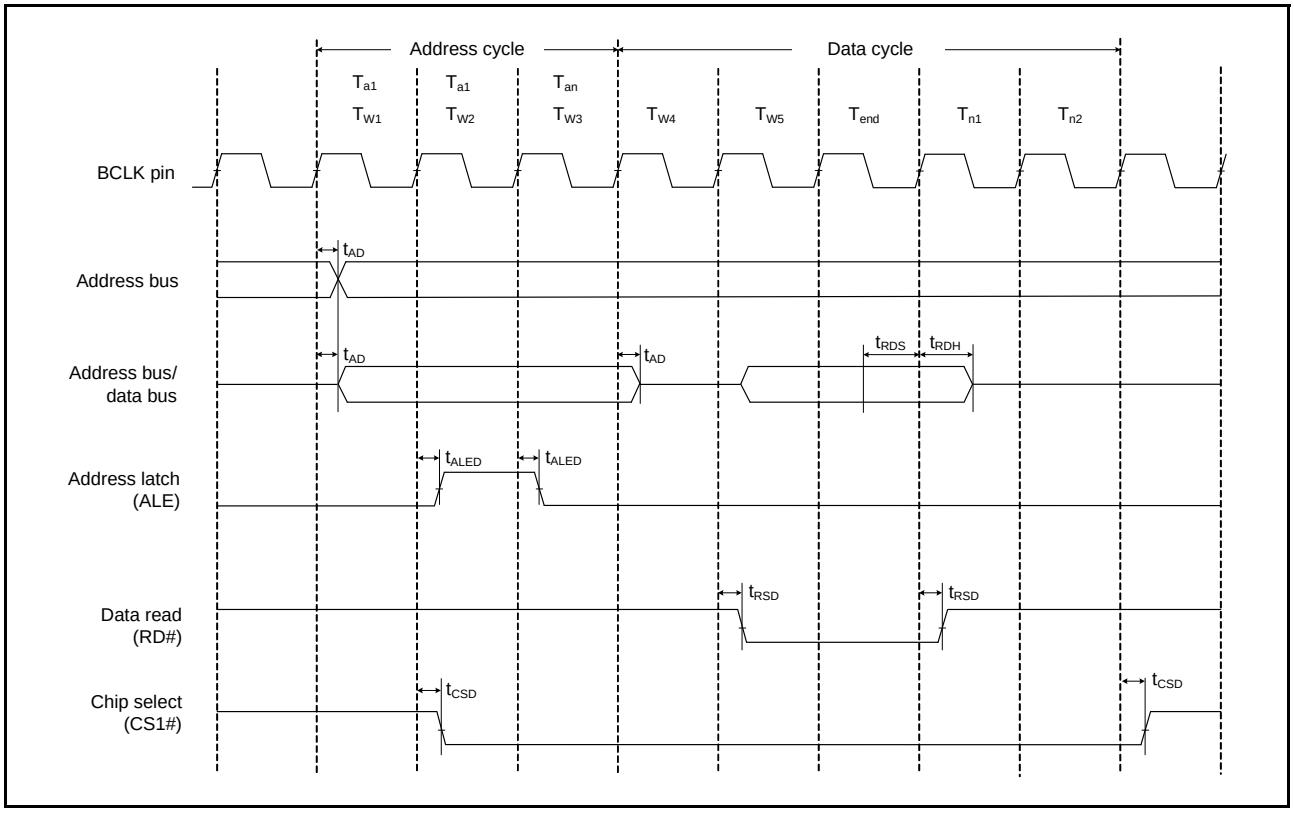


Figure 5.17 Address/Data Multiplexed Bus Read Access Timing

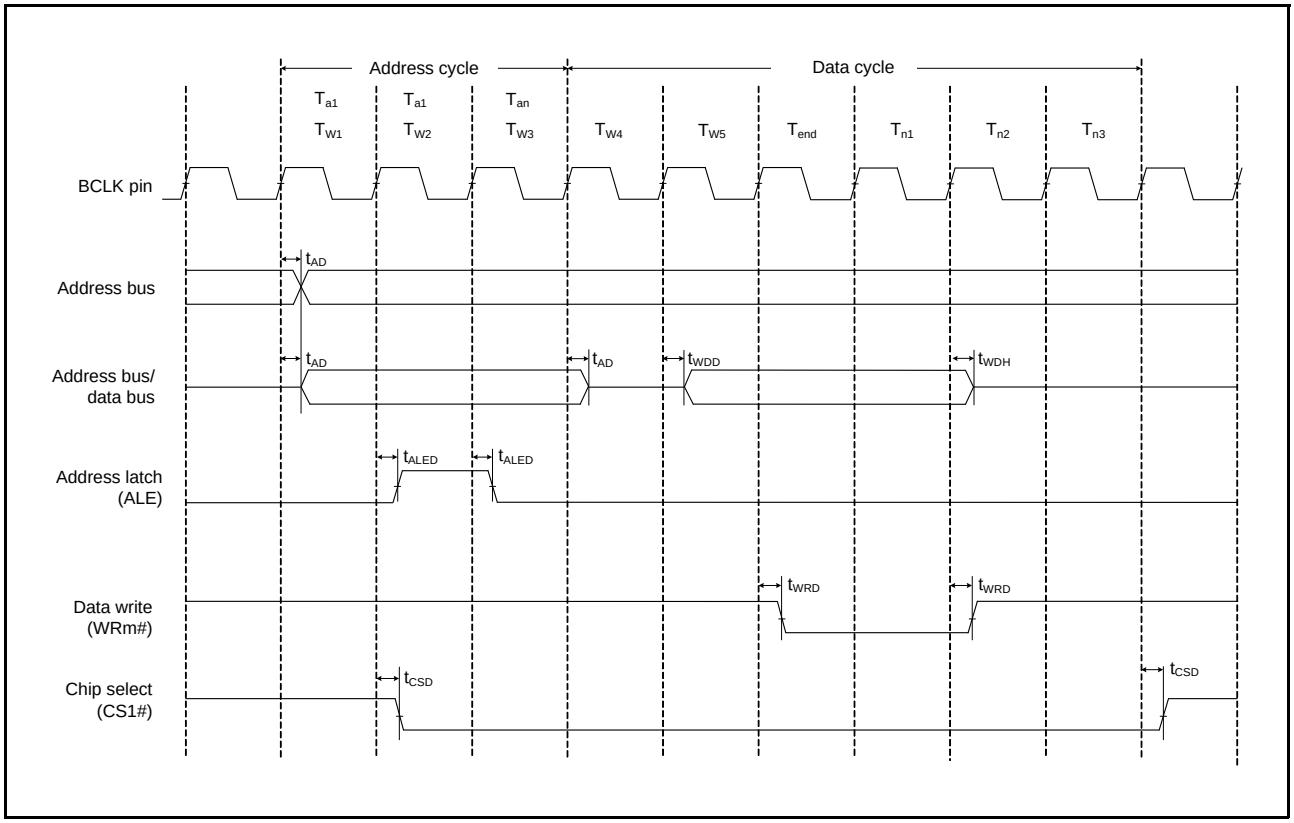


Figure 5.18 Address/Data Multiplexed Bus Write Access Timing

Table 5.20 Timing of On-Chip Peripheral Modules (2)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V*1, VREFH0 = 2.7 V to AVCC0*1,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V,
PCLK = 8 to 50 MHz,
$T_a = T_{opr}$
High drive output is selected by the drive capacity control register.

Item				Symbol	Min.	Max.	Unit*2	Test Conditions
RSPI	RSPCK clock cycle	Master		t_{SPcyc}	2	4096	t_{Pcyc}	Figure 5.42 C = 30pF
		Slave			8	4096		
	RSPCK clock high pulse width	Master		t_{SPCKWH}	$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2$	—		
	RSPCK clock low pulse width	Master		t_{SPCKWL}	$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2$	—		
	RSPCK clock rise/ fall time	Output [packages with 177 to 144 pins]		t_{SPCKr}, t_{SPCKf}	—	5	ns	
		Output [packages with 100 pins or less]			—	10		
		Input			—	1	μs	
	Data input setup time	Master [packages with 177 to 144 pins]	VCC ≥ 3.0 V	t_{SU}	15	—	ns	Figure 5.43 to Figure 5.46 C = 30pF
			VCC < 3.0 V		20	—		
		Master [packages with 100 pins or less]			30	—		
		Slave			$20 - t_{Pcyc}$	—		
	Data input hold time	Master		t_H	0	—	ns	
		Slave			$20 + 2 \times t_{Pcyc}$	—		
	SSL setup time	Master		t_{LEAD}	1	8	t_{SPcyc}	
		Slave			4	—	t_{Pcyc}	
	SSL hold time	Master		t_{LAG}	1	8	t_{SPcyc}	
		Slave			4	—	t_{Pcyc}	

Note 1. When operation at 3.0 V or a lower voltage is needed, please contact a Renesas sales office.
Note 2. t_{Pcyc}: PCLK cycle

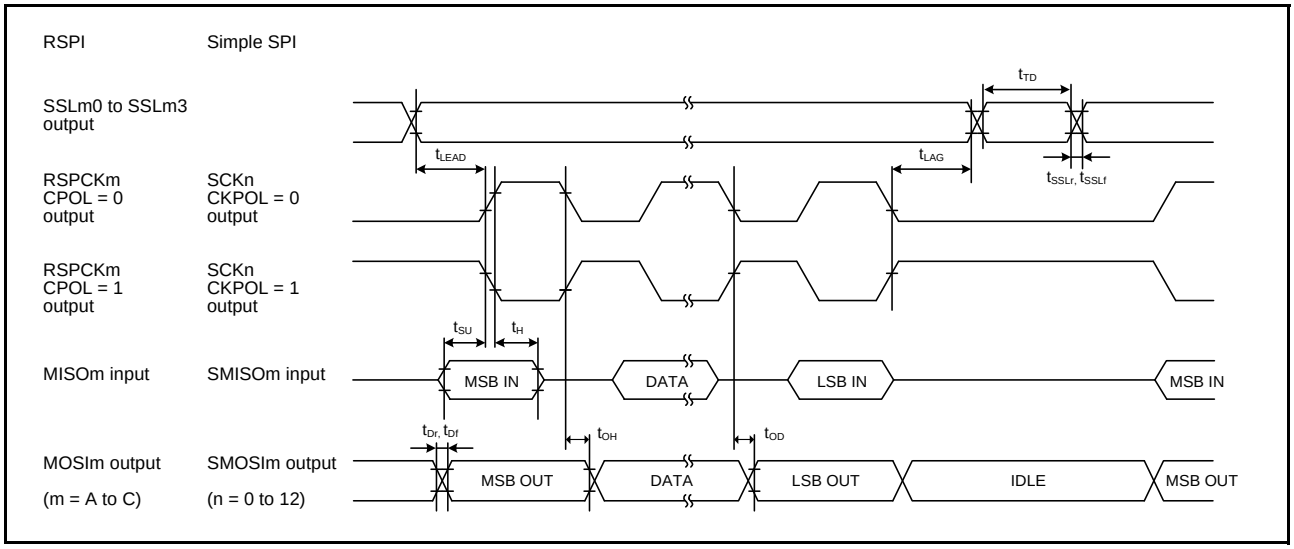


Figure 5.43 RSPI Timing (Master, CPHA = 0) and Simple SPI Timing (Master, CKPH = 1)

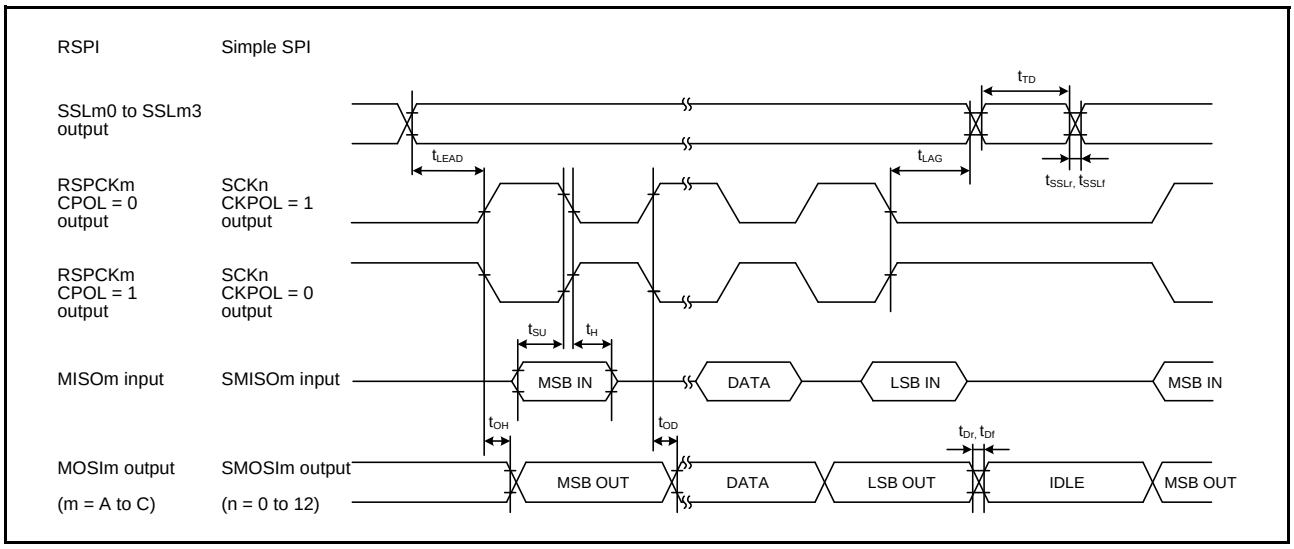


Figure 5.44 RSPI Timing (Master, CPHA = 1) and Simple SPI Timing (Master, CKPH = 0)

5.8 Power-on Reset Circuit and Voltage Detection Circuit Characteristics

Table 5.33 Power-on Reset Circuit and Voltage Detection Circuit Characteristics

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
$T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Power-on reset (POR)	Low power consumption function disabled	V_{POR}	2.5	2.6	2.7	V	Figure 5.63
		Low power consumption function enabled		2.0	2.35	2.7		
	Voltage detection circuit (LVD0)		V_{det0}	2.7	2.80	2.9		Figure 5.64
	Voltage detection circuit (LVD1)		V_{det1_A}	2.75	2.95	3.15		Figure 5.65
	Voltage detection circuit (LVD2)		V_{det2_A}	2.75	2.95	3.15		Figure 5.66
Internal reset time	Power-on reset time		t_{POR}	—	4.6	—	ms	Figure 5.63
	LVD0 reset time		t_{LVD0}	—	4.6	—		Figure 5.64
	LVD1 reset time		t_{LVD1}	—	0.9	—		Figure 5.65
	LVD2 reset time		t_{LVD2}	—	0.9	—		Figure 5.66
Minimum VCC down time			t_{VOFF}	200	—	—	µs	Figure 5.63 and Figure 5.64
Response delay time			t_{det}	—	—	200	µs	Figure 5.63 to Figure 5.66
LVD operation stabilization time (after LVD is enabled)			$Td_{(E-A)}$	—	—	3	µs	Figure 5.65 and Figure 5.66
Hysteresis width (LVD1 and LVD2)			V_{LVH}	—	80	—	mV	

Note: The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR}, V_{det1}, and V_{det2} for the POR/ LVD.

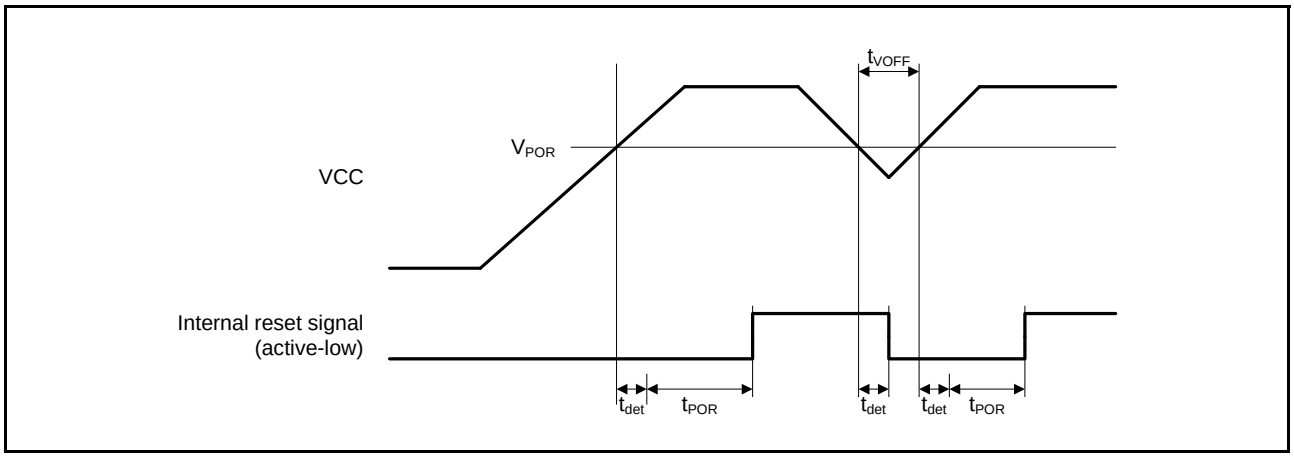


Figure 5.63 Power-on Reset Timing

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

   — The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.